



SPECIFICATIONS

Rated Current:3.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40℃ to +105℃

Contact Material:Copper Alloy

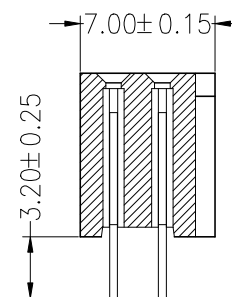
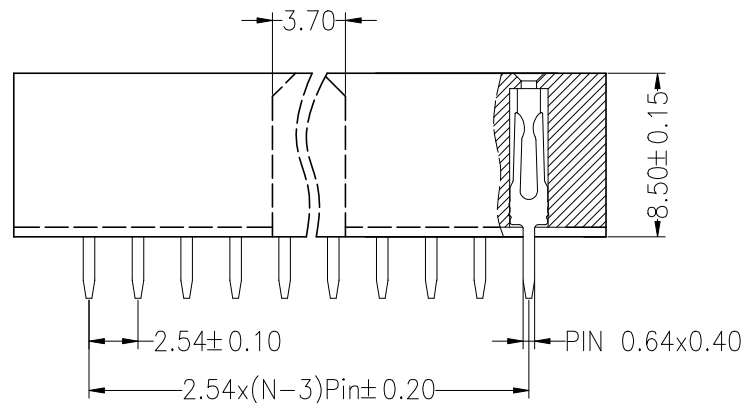
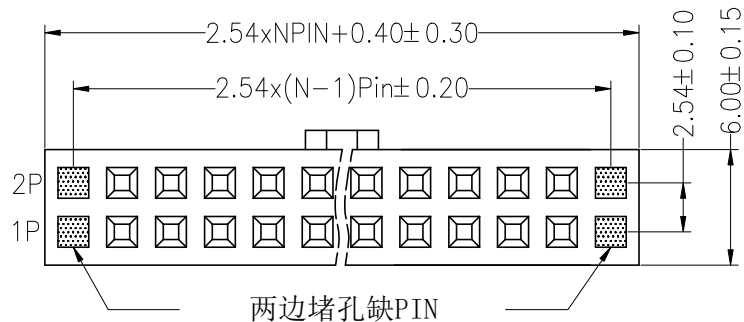
Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Resistance To Soldering Heat:

245° C±5° C, 10s(PBT insulator)

260° C±5° C, 10s(PA6T&PA9T&LCP insulator)



Ordering Information

2285 02 XX X N XX SYW X XX

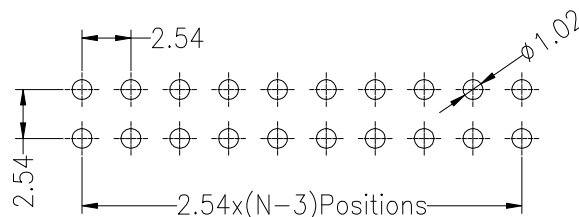
No. of Pins
Per Row
02~40P

Insulator Material
Option
A=BK-PBT
C=BK-PA6T
E=BK-PA9T
F=BK-LCP

Contact Plating
G1:Gold Flash
G2:1.5u" Gold
G3:2u" Gold
G4:3u" Gold
G5:5u" Gold
G6:10u" Gold
G7:15u" Gold
G8:30u" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
O=PE Bag
A=Tray
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar

code stream
01~99



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

				OPERATION		DRAW	Jelly Feng	22.07.27	SCALE	FIT	JILN® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5588	
				X.X	±0.30				CHECK			
				X.XX	±0.20	SIZE	A4	PART NO.				
A0	2022.07.27	NEW DRAWING		X.XXX	±0.10	SHEET	1/1					
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	Angle	APPROVE			PROJ.		TITLE:	2.54PF H8.5mm 2xNpin 180° W7.0带全凸
					DIM				TOL			